

Complementary Bias Resistor Transistors

R1 = 100 kΩ, R2 = ∞ kΩ

NPN and PNP Transistors with Monolithic Bias Resistor Network

NSBC115TPDP6

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

(T_A = 25°C both polarities Q1 (PNP) and Q2 (NPN), unless otherwise noted)

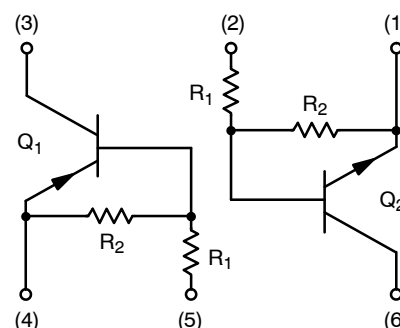
Symbol	Rating	Max	Unit
V _{CBO}	Collector-Base Voltage	50	Vdc
V _{CEO}	Collector-Emitter Voltage	50	Vdc
I _C	Collector Current – Continuous	100	mA _{dc}
V _{IN(fwd)}	Input Forward Voltage	40	Vdc
V _{IN(rev)}	Input Reverse Voltage	6	Vdc
	–NPN	5	
	–PNP		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

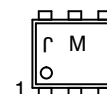


SOT-963
CASE 527AD

PIN CONNECTIONS



MARKING DIAGRAM



SOT-963
CASE 527AD

J = Specific Device Code
M = Date Code*

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping†
NSBC115TPDP6T5G	SOT-963	8,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

NSBC115TPDP6

THERMAL CHARACTERISTICS

Symbol	Characteristic	Max	Unit
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NSBC115TPDP6 (SOT-963) One Junction Heated

P_D	Total Device Dissipation		
	$T_A = 25^\circ\text{C}$ (Note 1)	231	mW
	(Note 2)	269	
	Derate above 25°C (Note 1)	1.9	mW/ $^\circ\text{C}$
$R_{\theta JA}$	(Note 2)	2.2	
	Thermal Resistance, Junction to Ambient (Note 1)	540	$^\circ\text{C}/\text{W}$
	(Note 2)	464	

NSBC115TPDP6 (SOT-963) Both Junction Heated (Note 3)

P_D	Total Device Dissipation		
	$T_A = 25^\circ\text{C}$ (Note 1)	339	mW
	(Note 2)	408	
	Derate above 25°C (Note 1)	2.7	mW/ $^\circ\text{C}$
$R_{\theta JA}$	(Note 2)	3.3	
	Thermal Resistance, Junction to Ambient (Note 1)	369	$^\circ\text{C}/\text{W}$
	(Note 2)	306	
T_J, T_{stg}	Junction and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

1. FR-4 @ 100 mm², 1 oz. copper traces, still air.
2. FR-4 @ 500 mm², 1 oz. copper traces, still air.
3. Both junction heated values assume total power is sum of two equally powered channels.

NSBC115TPDP6

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ both polarities Q_1 (PNP) and Q_2 (NPN), unless otherwise noted)

Symbol	Characteristic	Min	Typ	Max	Unit
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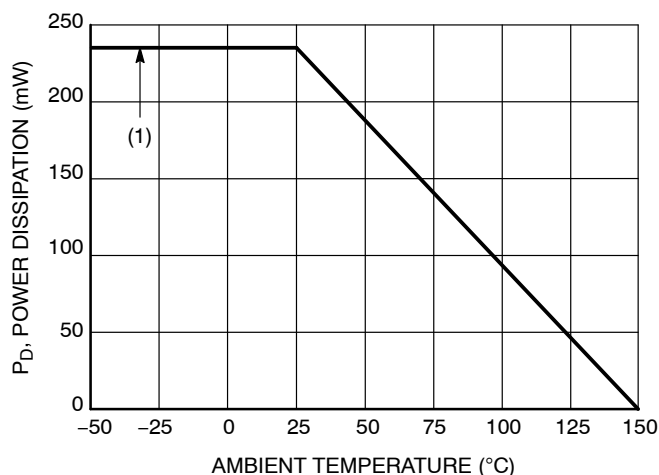
OFF CHARACTERISTICS

I_{CBO}	Collector-Base Cutoff Current ($V_{CB} = 50\text{ V}$, $I_E = 0$)	–	–	100	nAdc
I_{CEO}	Collector-Emitter Cutoff Current ($V_{CE} = 50\text{ V}$, $I_B = 0$)	–	–	500	nAdc
I_{EBO}	Emitter-Base Cutoff Current ($V_{EB} = 6.0\text{ V}$, $I_C = 0$)	–	–	0.1	mAdc
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage ($I_C = 10\text{ }\mu\text{A}$, $I_E = 0$)	50	–	–	Vdc
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage (Note 4) ($I_C = 2.0\text{ mA}$, $I_B = 0$)	50	–	–	Vdc

ON CHARACTERISTICS

h_{FE}	DC Current Gain (Note 4) ($I_C = 5.0\text{ mA}$, $V_{CE} = 10\text{ V}$)	160	350	–	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage (Note 4) ($I_C = 10\text{ mA}$, $I_B = 1.0\text{ mA}$)	–	–	0.25	Vdc
$V_{i(off)}$	Input Voltage (off) ($V_{CE} = 5.0\text{ V}$, $I_C = 100\text{ }\mu\text{A}$) (NPN) ($V_{CE} = 5.0\text{ V}$, $I_C = 100\text{ }\mu\text{A}$) (PNP)	– –	0.6 0.62	– –	Vdc
$V_{i(on)}$	Input Voltage (on) ($V_{CE} = 0.2\text{ V}$, $I_C = 1.0\text{ mA}$) (NPN) ($V_{CE} = 0.2\text{ V}$, $I_C = 1.0\text{ mA}$) (PNP)	– –	1.0 1.0	– –	Vdc
V_{OL}	Output Voltage (on) ($V_{CC} = 5.0\text{ V}$, $V_B = 3.5\text{ V}$, $R_L = 1.0\text{ k}\Omega$)	–	–	0.2	Vdc
V_{OH}	Output Voltage (off) ($V_{CC} = 5.0\text{ V}$, $V_B = 0.25\text{ V}$, $R_L = 1.0\text{ k}\Omega$)	4.9	–	–	Vdc
R_1	Input Resistor	70	100	130	$\text{k}\Omega$
R_1/R_2	Resistor Ratio	–	–	–	

4. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle $\leq 2\%$.



(1) SOT-963; 100 mm², 1 oz. copper trace

Figure 1. Derating Curve

TYPICAL CHARACTERISTICS – NPN TRANSISTOR
NSBC115TPDP6

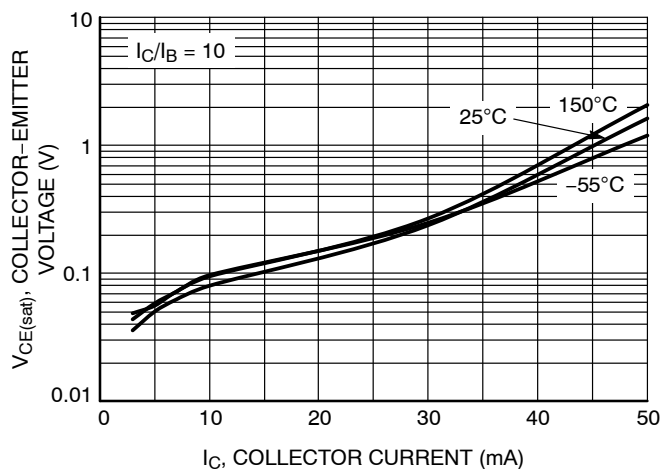


Figure 2. $V_{CE(sat)}$ vs. I_C

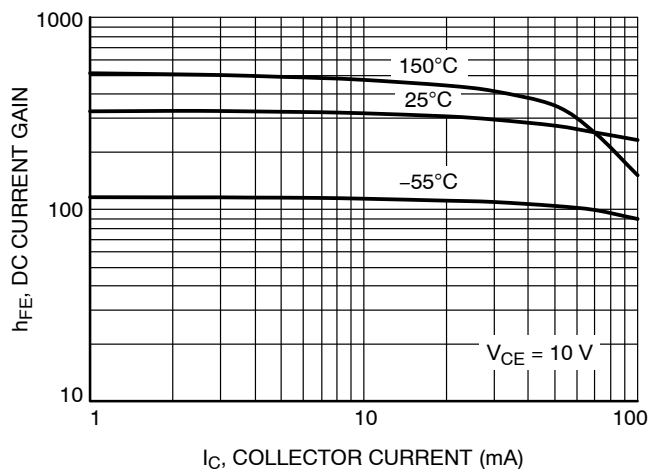


Figure 3. DC Current Gain

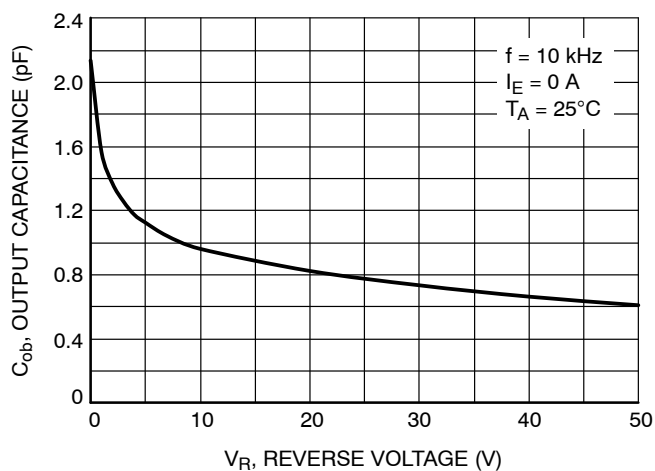


Figure 4. Output Capacitance

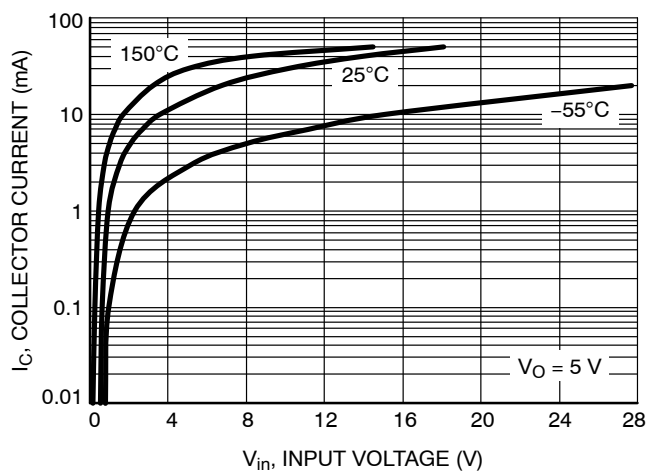


Figure 5. Output Current vs. Input Voltage

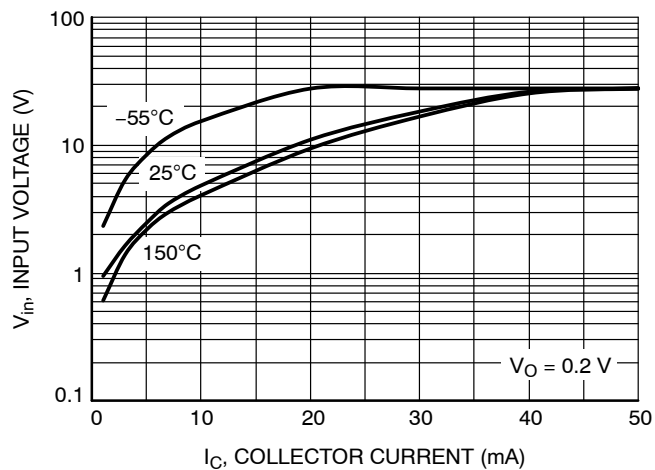


Figure 6. Input Voltage vs. Output Current

NSBC115TPDP6

TYPICAL CHARACTERISTICS – PNP TRANSISTOR NSBC115TPDP6

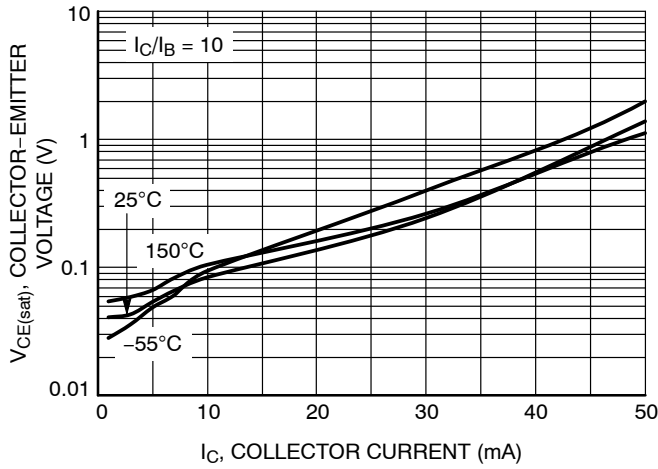


Figure 7. $V_{CE(sat)}$ vs. I_C

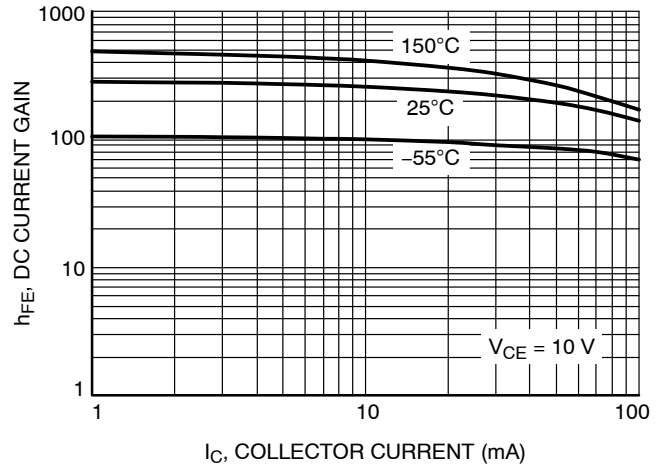


Figure 8. DC Current Gain

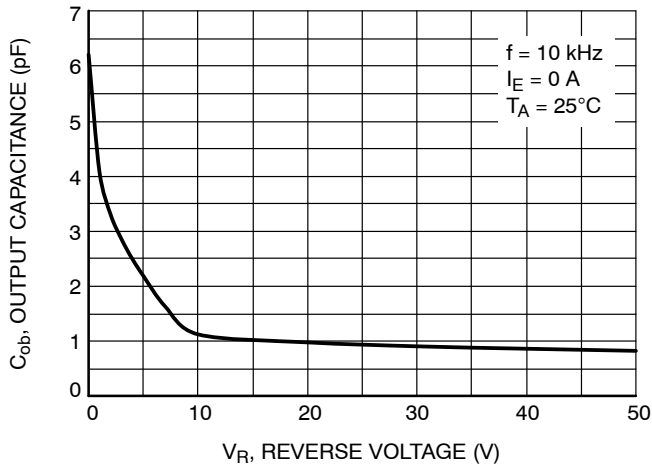


Figure 9. Output Capacitance

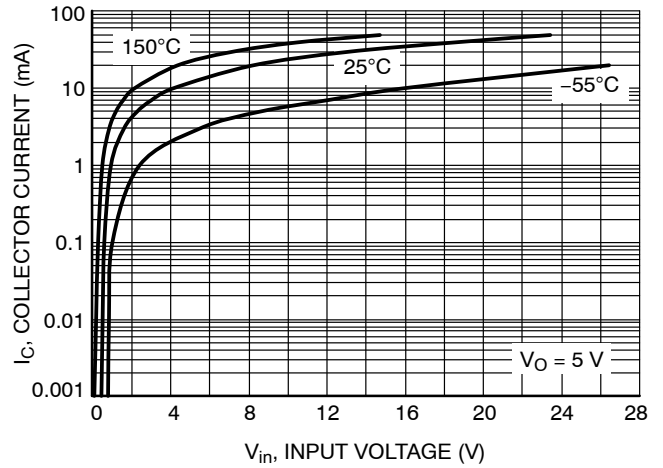


Figure 10. Output Current vs. Input Voltage

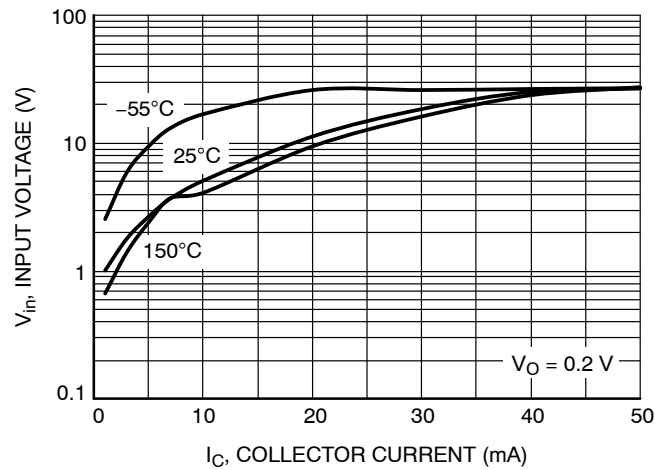
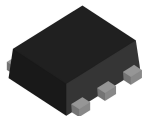


Figure 11. Input Voltage vs. Output Current

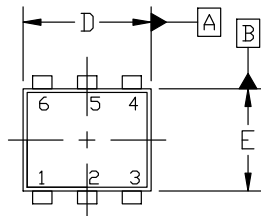


SOT-963 1.00x1.00x0.37, 0.35P
CASE 527AD
ISSUE F

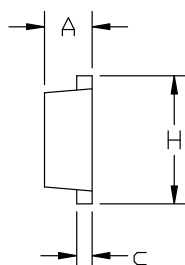
DATE 20 FEB 2024

NOTES:

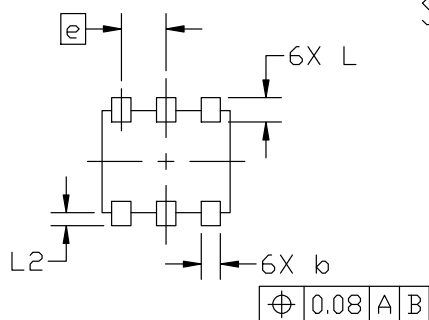
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.



TOP VIEW

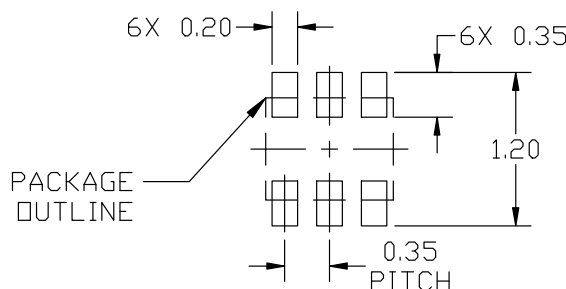


SIDE VIEW



BOTTOM VIEW

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.34	0.37	0.40
b	0.10	0.15	0.20
c	0.07	0.12	0.17
D	0.95	1.00	1.05
E	0.75	0.80	0.85
e	0.35 BSC		
H	0.95	1.00	1.05
L	0.19 REF		
L2	0.05	0.10	0.15



RECOMMENDED MOUNTING
FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference manual, SOLDERRM/D.

STYLE 1:

- PIN 1. EMITTER 1
2. BASE 1
3. COLLECTOR 2
4. EMITTER 2
5. BASE 2
6. COLLECTOR 1

STYLE 2:

- PIN 1. EMITTER 1
2. EMITTER 2
3. BASE 2
4. COLLECTOR 2
5. BASE 1
6. COLLECTOR 1

STYLE 3:

- PIN 1. CATHODE 1
2. CATHODE 1
3. ANODE/ANODE 2
4. CATHODE 2
5. CATHODE 2
6. ANODE/ANODE 1

STYLE 4:

- PIN 1. COLLECTOR
2. COLLECTOR
3. BASE
4. EMITTER
5. COLLECTOR
6. COLLECTOR

STYLE 5:

- PIN 1. CATHODE
2. CATHODE
3. ANODE
4. ANODE
5. CATHODE
6. CATHODE

STYLE 6:

- PIN 1. CATHODE
2. ANODE
3. CATHODE
4. CATHODE
5. CATHODE
6. CATHODE

STYLE 7:

- PIN 1. CATHODE
2. ANODE
3. CATHODE
4. CATHODE
5. ANODE
6. CATHODE

STYLE 8:

- PIN 1. DRAIN
2. DRAIN
3. GATE
4. SOURCE
5. DRAIN
6. DRAIN

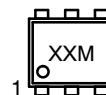
STYLE 9:

- PIN 1. SOURCE 1
2. GATE 1
3. DRAIN 2
4. SOURCE 2
5. GATE 2
6. DRAIN 1

STYLE 10:

- PIN 1. CATHODE 1
2. N/C
3. CATHODE 2
4. ANODE 2
5. N/C
6. ANODE 1

**GENERIC
MARKING DIAGRAM***



XX = Specific Device Code
M = Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SOT-963 1.00x1.00x0.37, 0.35P	PAGE 1 OF 1

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